



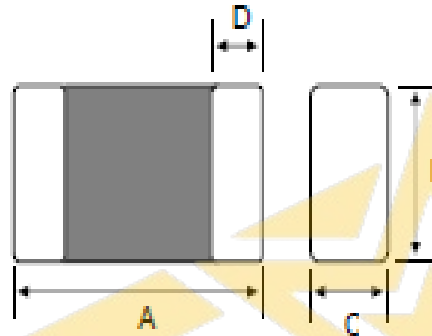
Physical Dimensions : mm (inch)

A = 2.0 ± 0.2 (0.079 \pm 0.008)

B = 1.2 ± 0.2 (0.047 \pm 0.008)

C = 0.9 ± 0.2 (0.035 \pm 0.008)

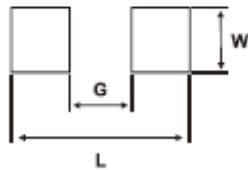
D = 0.5 ± 0.3 (0.020 \pm 0.012)



General Information :

1. Termination Finish is 100% Tin.
2. Components Should be Adequately Preheated Before Soldering.
3. Operating Temperature: -55°C to +125°C
4. Storage Temperature (on Tape & Reel): 40°C MAX. , 70% RH

Land Patterns for Reflow Soldering



| L | W | G |
|-------------|-------------|-------------|
| 3.20(0.126) | 1.50(0.059) | 0.60(0.024) |

Packing Method:

One reel = 4,000 pcs

One Box = 200,000 pcs

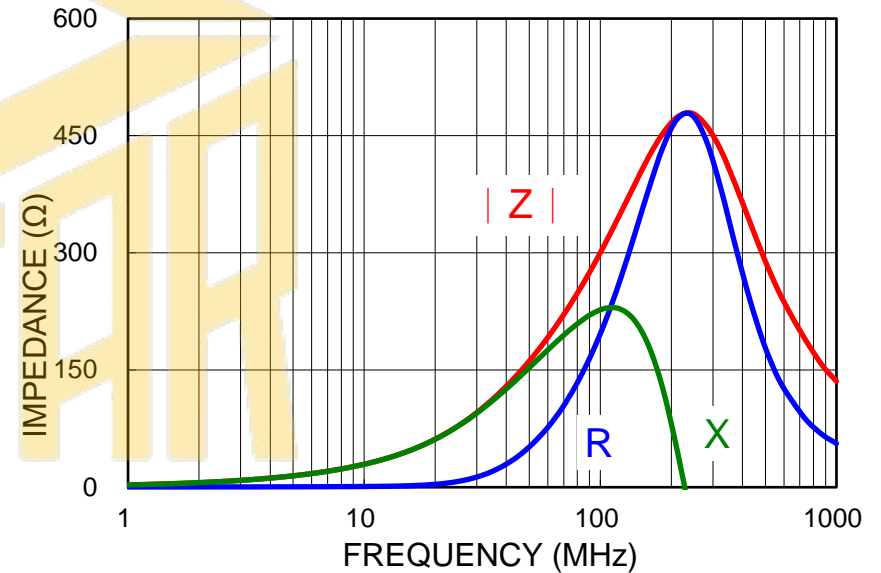
One Box = 10.3 KG

Electrical Characteristics :

| | Value | Unit | Tolerance | Test Condition |
|-----------|-------|----------|------------|----------------|
| Impedance | 300 | Ω | $\pm 25\%$ | 100MHz / 100mV |
| DCR | 0.30 | Ω | Max. | |
| IDC | 200 | mA | Max. | |

Typical Impedance Characteristics : HP 4291B

TB201209G301



Multilayer Ferrite Chip Beads

P/N TB 201209 G301

Version N000



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| N000 | Initial | | |
|------|-------------|------|----|
| VER. | DESCRIPTION | DATE | BY |
| | | | |